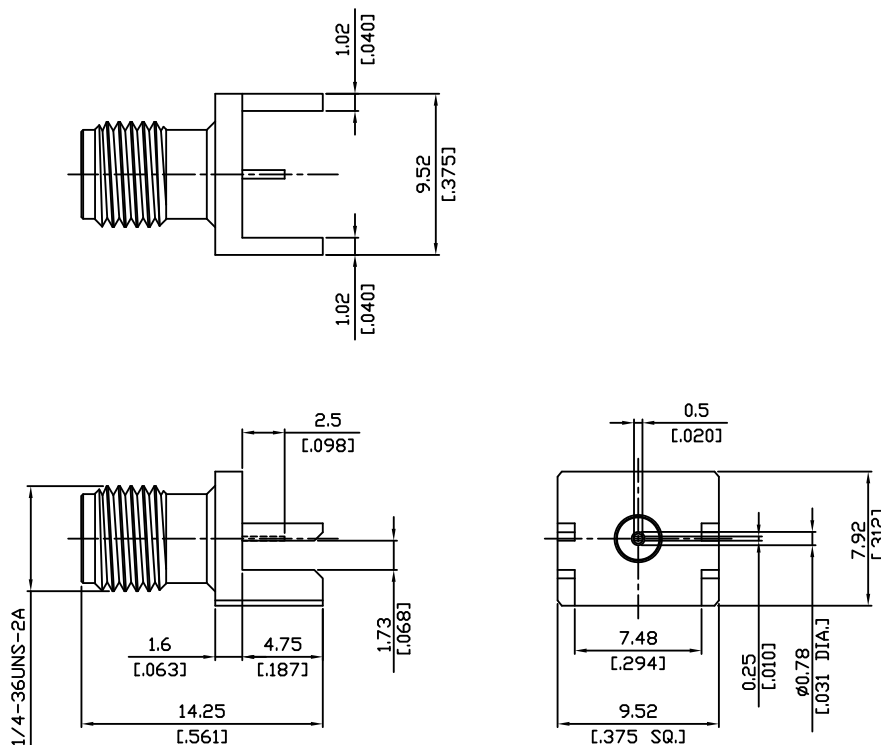


SMA Jack (Female) PCB End Launch Connector Solder Attachment
Teflon Design DC-18GHz

SMA2H2B50-0173B / 91



All dimensions are in mm [inch]

Tolerances according to DIN ISO 2768-mH

Interface

According to

IEC60169-15, MIL-STD-348B/310

Electrical Data

Impedance

50 Ω

Frequency

DC to 18 GHz

VSWR (Return Loss)

≤ 1.20 (≥ 20.83 dB) @ 6 GHz

≤ 1.30 (≥ 17.69 dB) @ 18 GHz

Insertion Loss

≤ 0.03 x √F (GHz) dB

Insulation Resistance

≥ 5 GΩ

Center Contact Resistance

≤ 3.0 mΩ

Outer Contact Resistance

≤ 2.0 mΩ

Test Voltage (at sea level)

1000 V rms

Working Voltage (at sea level)

480 V rms

Power Handling (at 20 °C, sea level, VSWR 1.0)

≤ 200 W @ 2 GHz

≤ 100 W @ 10 GHz

RF Leakage

≤ 100 dB up to 1 GHz

- VSWR in application depends decisive on PCB layout -

Material And Plating

Piece Parts	Material	Plating
Centre contact	Beryllium Copper	Gold plating, 3 μinch (Non-magnetic nickel-phosphorus underplating, 80 μinch)
Body	Brass	Gold plating, 3 μinch (Non-magnetic nickel-phosphorus underplating, 80 μinch)
Insulator	PTFE	

SMA Jack (Female) PCB End Launch Connector Solder Attachment
Teflon Design DC-18GHz

SMA2H2B50-0173B / 91

Mechanical Data

Coupling mechanisms	Screw-lock
Mating cycles	min. 500
Center contact captivation: axial	≥ 20 N
Board mounting type	End Launch
Coupling test torque	max. 1.7 Nm
Recommended torque	0.8 Nm to 1.1 Nm

Environmental Data

Temperature Range	-65°C to +165°C
Thermal shock	MIL-STD-202, Meth. 107, Cond. B
Corrosion	MIL-STD-202, Meth. 101, Cond. B
Vibration	MIL-STD-202, Meth. 204, Cond. D
Shock	MIL-STD-202, Meth. 213, Cond. I
Moisture Resistance	MIL-STD-202, Meth. 106
RoHS	compliant

Packing

Standard	Single or 100
----------	---------------